

Amendments to the Specification

Please insert the following paragraph before the paragraph at page 1, line 8:

This application is a continuation-in-part of U.S. Appl. No. 09/239,043, filed January 27, 1999, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 08/347,610, filed December 1, 1994, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 08/344,824, filed November 23, 1994, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 08/205,713, filed March 4, 1994, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 09/189,702, filed November 10, 1998, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 08/820,360, filed March 12, 1997, which is herein incorporated by reference; and is a continuation-in-part of U.S. Appl. No. 08/197,484, filed February 16, 1994, U.S. Patent No. 6,419,931, which is herein incorporated by reference; which is a continuation-in-part of U.S. Appl. No. 07/935,811, filed August 26, 1992, abandoned, which is herein incorporated by reference; which is a continuation-in-part of U.S. Appl. No. 07/874,491, filed April 27, 1992, abandoned, which is herein incorporated by reference; which is a continuation-in-part of 07/827,682, filed January 29, 1992, abandoned, which is herein incorporated by reference; said Appl. No. 08/347,610 is a continuation-in-part of Appl. No. 08/159,339, filed November 29, 1993, U.S. Patent No. 6,037,135, which is herein incorporated by reference; which is a continuation-in-part of Appl. No. 08/103,396, filed August 6, 1993, abandoned, which is herein incorporated by reference; which is a continuation-in-part of U.S. Appl. No. 08/027,746, filed March 5, 1993, abandoned, which is herein incorporated by reference; which is a continuation-in-part of U.S. Appl. No. 07/926,666, filed August 7, 1992,

abandoned, which is herein incorporated by reference; said Appl. No. 08/344,824 is a continuation-in-part of Appl. No. 08/278,634, filed July 21, 1994, abandoned, which is herein incorporated by reference; said Appl. No. 08/205,713 is a continuation-in-part of Appl. No. 08/159,184, filed November 29, 1993, abandoned, which is herein incorporated by reference; which is a continuation-in-part of Appl. No. 08/073,205, filed June 4, 1993, abandoned, which is herein incorporated by reference; which is a continuation-in-part of Appl. No. 08/027,146, filed March 5, 1993, abandoned, which is herein incorporated by reference; said Appl. No. 09/189,702 is a continuation-in-part of said Appl. No. 08/205,713; said Appl. No. 08/820,360 claims the benefit of U.S. Provisional Application No. 60/013,363, filed March 13, 1996, which is herein incorporated by reference; the present application is also a continuation-in-part of U.S. Appl. No. 08/978,291, filed November 25, 1997; which is a continuation of U.S. Appl. No. 08/461,603, filed June 5, 1995, which is herein incorporated by reference; which is a continuation of said Appl. No. 07/935,811.

Please replace the paragraph at page 1, line 8 with the following paragraph:

~~This application is a Continuation-In-Part ("CIP") of U.S.S.N. 08/820,360 filed 3/12/97, which claims the benefit of U.S. Provisional Application No. 60/103,363 filed March 13, 1996 and now abandoned. The present application is also a CIP of U.S.S.N. 09/189,702, filed 11/10/98, which is a CIP of 08/205,713, filed 3/4/94, which is a CIP of 08/159,184, filed 11/29/93 and now abandoned, which is a CIP of 08/073,205, filed 6/4/93 and now abandoned, which is a CIP of 08/027,146, filed 3/5/93 and now abandoned. The present application is also related to U.S.S.N. 08/197,484, U.S.S.N. 08/464,234, U.S.S.N. 08/464,496, U.S.S.N. 08/464,031, abandoned U.S.S.N. 08/464,433, and U.S.S.N.~~

08/461,603, which is a continuation of abandoned U.S.S.N. 07/935,811, which is a CIP of abandoned U.S.S.N. 07/874,491, which is a CIP of abandoned U.S.S.N. 07/827,682, which is a CIP of abandoned 07/749,568. The present application is also related to ~~U.S. Patent Application entitled "Peptides and Methods for Creating Synthetic Peptides with Modulated Binding Affinity for HLA Molecules", Attorney Docket No. 018623-009520, filed 1/6/99,~~U.S.S.N. 09/226,675, filed 1/6/99, which is a CIP of U.S.S.N. 08/815,396, which is a CIP of abandoned U.S.S.N. 60/013,113. Furthermore, the present application is related to U.S.S.N. 09/017,735, which is a CIP of abandoned U.S.S.N. 08/589,108; U.S.S.N. 08/753,622, U.S.S.N. 08/822,382, abandoned U.S.S.N. 60/013,980, U.S.S.N. 08/454,033, U.S.S.N. 09/116,424, U.S.S.N. 08/205,713, and U.S.S.N. 08/349,177, which is a CIP of abandoned U.S.S.N. 08/159,184, which is a CIP of abandoned U.S.S.N. 08/073,205, which is a CIP of abandoned U.S.S.N. 08/027,146. The present application is also related to U.S.S.N. 09/017,524, U.S.S.N. 08/821,739, abandoned U.S.S.N. 60/013,833, U.S.S.N. 08/758,409, U.S.S.N. 08/589,107, U.S.S.N. 08/451,913, U.S.S.N. 08/186,266, U.S.S.N. 09/116,061, and U.S.S.N. 08/347,610, which is a CIP of U.S.S.N. 08/159,339, which is a CIP of abandoned U.S.S.N. 08/103,396, which is a CIP of abandoned U.S.S.N. 08/027,746, which is a CIP of abandoned U.S.S.N. 07/926,666. The present application is also related to U.S.S.N. 09/017,743, U.S.S.N. 08/753,615; U.S.S.N. 08/590,298, U.S.S.N. 09/115,400, and U.S.S.N. 08/452,843, which is a CIP of U.S.S.N. 08/344,824, which is a CIP of abandoned U.S.S.N. 08/278,634. The present application is also related to provisional U.S.S.N. 60/087,192 and U.S.S.N. 09/009,953, which is a CIP of abandoned U.S.S.N. 60/036,713 and abandoned U.S.S.N. 60/037,432. In addition, the present application is

related to U.S.S.N. 09/098,584 and to U.S.S.N. 60/117,486, filed 1/27/99. All of the above applications in this paragraph are incorporated herein by reference.

Please replace the paragraph beginning at page 13, line 18 with the following paragraph:

The term "peptide" is used interchangeably with "oligopeptide" in the present specification to designate a series of residues, typically L-amino acids, connected one to the other, typically by peptide bonds between the α -amino and carboxyl groups of adjacent amino acids. The preferred CTL-inducing oligopeptides of the invention are less than 15 residues in length, or 13 residues or less in length and usually consist of between about 8 and about 11 residues, preferably 9 or 10 residues. The preferred HTL-inducing oligopeptides are less than about 50 residues in length and usually consist of between about 6 and about 30 residues, more usually between about 12 and 25, and often between about 15 and 20 residues.